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FQN1N50C

N-Channel QFET® MOSFET

500 V, 0.38 A, 6 Ω

Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 0.38 A, 500 V, $R_{DS(on)} = 6 \Omega$ (Max.) @ $V_{GS} = 10$ V, $I_D = 0.19$ A
- Low Gate Charge (Typ. 4.9 nC)
- Low $Crss$ (Typ. 4.1 pF)
- 100% Avalanche Tested



Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	FQN1N50CTA	Unit
V_{DSS}	Drain-Source Voltage	500	V
I_{DR}	Drain Current - Continuous ($T_C = 25^\circ\text{C}$)	0.38	A
	- Continuous ($T_C = 100^\circ\text{C}$)	0.24	A
I_{DM}	Drain Current - Pulse	(Note 1)	A
V_{GSS}	Gate-Source Voltage	± 30	V
E_{AS}	Single Pulsed Avalanche Energy	(Note 2)	mJ
I_{AR}	Avalanche Current	(Note 1)	A
E_{AR}	Repetitive Avalanche Energy	(Note 1)	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	V/ns
P_D	Power Dissipation ($T_A = 25^\circ\text{C}$)	0.89	W
	Power Dissipation ($T_L = 25^\circ\text{C}$)	2.08	W
	- Derate above 25°C	0.017	W/ $^\circ\text{C}$
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to +150	$^\circ\text{C}$
T_L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds.	300	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	FQN1N50CTA	Unit
$R_{\theta JL}$	Thermal Resistance, Junction-to-Lead, Max. (Note 5a)	60	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max. (Note 5b)	140	$^\circ\text{C}/\text{W}$

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQN1N50CTA	1N50C	TO-92	AMMO	N/A	N/A	2000 units

Electrical Characteristics

$T_C = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}$, $I_D = 250 \mu\text{A}$	500	--	--	V
$\Delta \text{BV}_{\text{DSS}} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$, Referenced to 25°C	--	0.5	--	$\text{V}/^\circ\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 500 \text{ V}$, $V_{\text{GS}} = 0 \text{ V}$	--	--	100	μA
		$V_{\text{DS}} = 400 \text{ V}$, $T_C = 125^\circ\text{C}$	--	--	200	μA
I_{GSSF}	Gate-Body Leakage Current, Forward	$V_{\text{GS}} = 30 \text{ V}$, $V_{\text{DS}} = 0 \text{ V}$	--	--	100	nA
I_{GSSR}	Gate-Body Leakage Current, Reverse	$V_{\text{GS}} = -30 \text{ V}$, $V_{\text{DS}} = 0 \text{ V}$	--	--	-100	nA
On Characteristics						
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}$, $I_D = 10 \mu\text{A}$	2.0	--	4.0	V
$R_{\text{DS(on)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}} = 10 \text{ V}$, $I_D = 1.0 \text{ A}$	--	4.6	6.0	Ω
g_{FS}	Forward Transconductance	$V_{\text{DS}} = 25 \text{ V}$, $I_D = 1.0 \text{ A}$	--	0.8	--	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DD}} = 25 \text{ V}$, $V_{\text{GS}} = 0 \text{ V}$, $f = 1.0 \text{ MHz}$	--	150	195	pF
C_{oss}	Output Capacitance		--	28	40	pF
C_{rss}	Reverse Transfer Capacitance		--	4.1	--	pF
Switching Characteristics						
$t_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{DD}} = 250 \text{ V}$, $I_D = 1.0 \text{ A}$, $R_G = 25 \Omega$	--	10	30	ns
t_r	Turn-On Recovery Time		--	10	30	ns
$t_{\text{d(off)}}$	Turn-Off Delay Time		--	20	50	ns
	Turn-Off Fall Time		--	15	40	ns
Q_{g}	Total Gate Charge	$V_{\text{DS}} = 400 \text{ V}$, $I_D = 1.0 \text{ A}$, $V_{\text{GS}} = 10 \text{ V}$	--	4.9	6.4	nC
Q_{gs}	Gate-Source Charge		--	0.66	--	nC
Q_{gd}	Gate-Drain Charge		--	2.9	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I_{S}	Maximum Continuous Drain-Source Diode Forward Current		--	--	0.38	A
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current		--	--	3.04	A
V_{SD}	Drain-Source Diode Forward Voltage	$V_{\text{GS}} = 0 \text{ V}$, $I_{\text{S}} = 0.38 \text{ A}$	--	--	1.4	V
t_{rr}	Reverse Recovery Time	$V_{\text{GS}} = 0 \text{ V}$, $I_{\text{S}} = 1.0 \text{ A}$, $dI_{\text{F}} / dt = 100 \text{ A}/\mu\text{s}$	--	188	--	ns
Q_{rr}	Reverse Recovery Charge		--	0.55	--	μC

Notes:

1. Repetitive rating : pulse-width limited by maximum junction temperature.
2. $L = 80 \text{ mH}$, $I_{\text{AS}} = 1.0 \text{ A}$, $V_{\text{DD}} = 50 \text{ V}$, $R_G = 25 \Omega$, starting $T_J = 25^\circ\text{C}$.
3. $I_{\text{SD}} \leq 0.38 \text{ A}$, $di/dt \leq 200 \text{ A}/\mu\text{s}$, $V_{\text{DD}} \leq \text{BV}_{\text{DSS}}$, starting $T_J = 25^\circ\text{C}$.
4. Essentially independent of operating temperature.
5. a) Reference point of the R_{QJA} is the drain lead.
b) When mounted on 3"x4.5" FR-4 PCB without any pad copper in a still air environment
(R_{QJA} is the sum of the junction-to-case and case-to-ambient thermal resistance. R_{QCA} is determined by the user's board design)

Typical Performance Characteristics

Figure 1. On-Region Characteristics

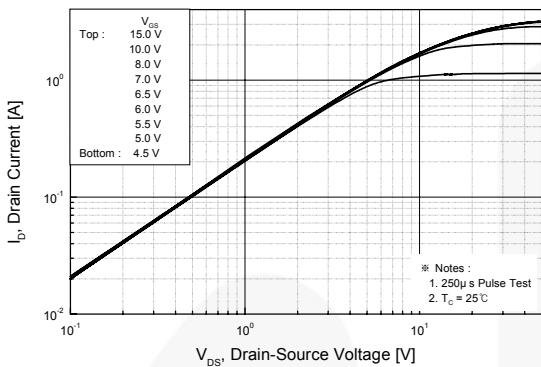


Figure 2. Transfer Characteristics

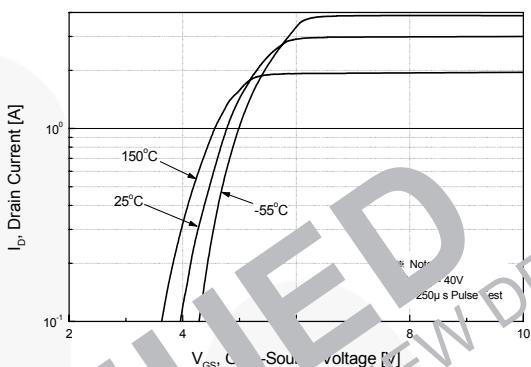


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

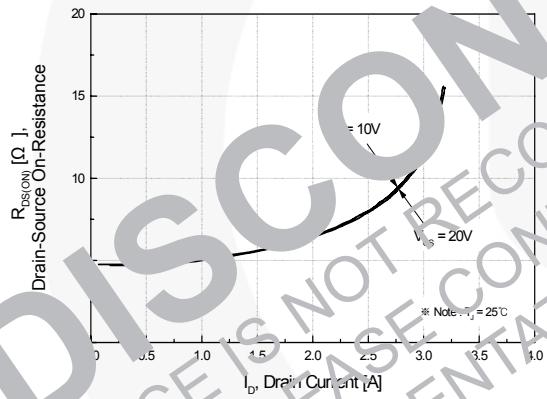


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

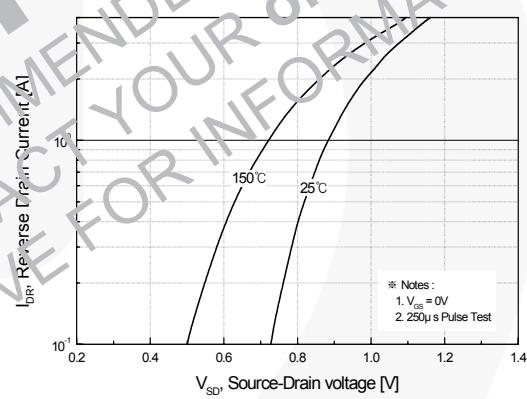


Figure 5. Capacitance Characteristics

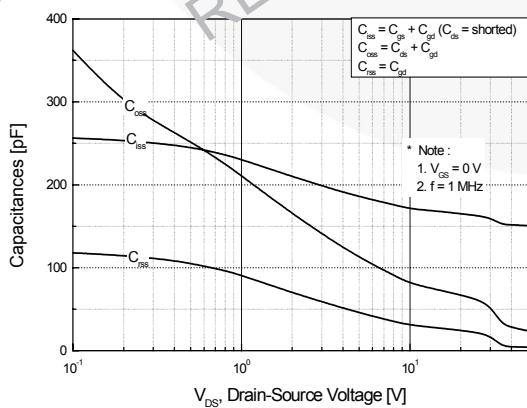
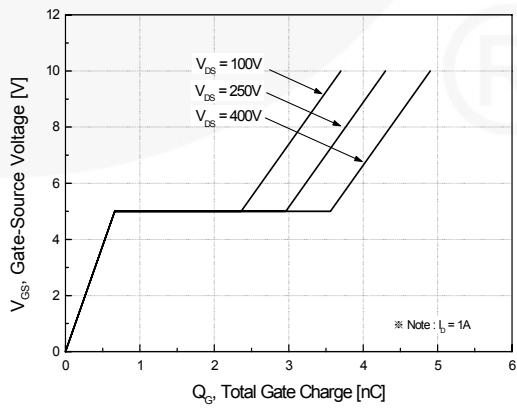


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

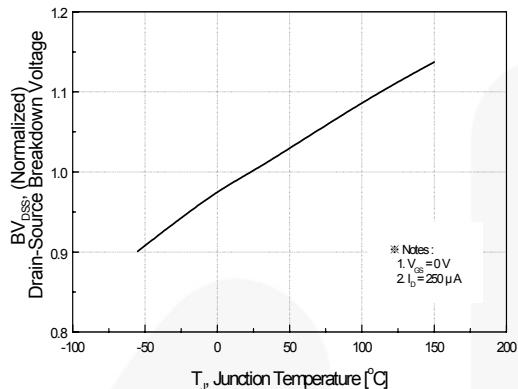


Figure 8. On-Resistance Variation vs. Temperature

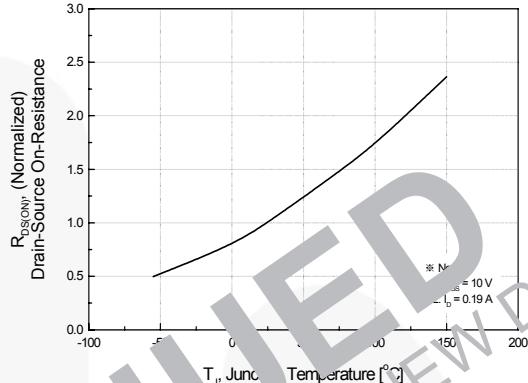


Figure 9. Maximum Safe Operating Area

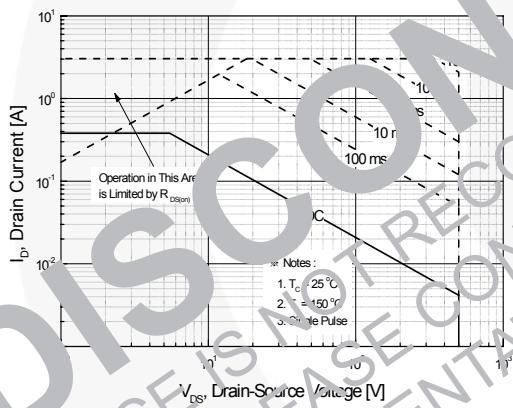


Figure 10. Maximum Drain Current vs. Case Temperature

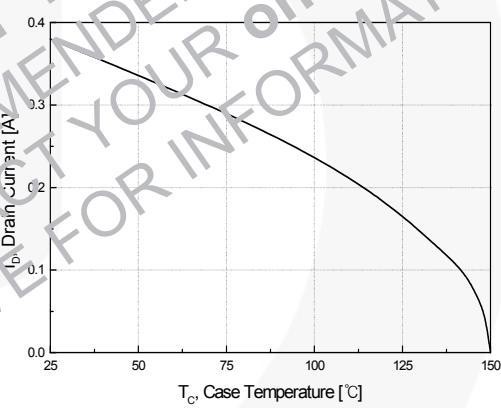
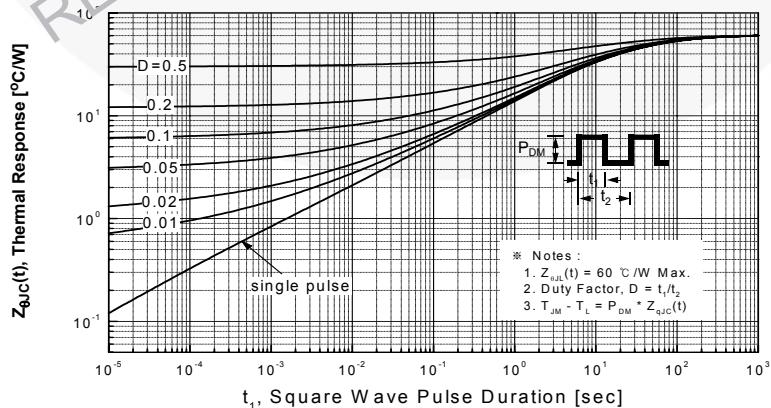


Figure 11. Transient Thermal Response Curve



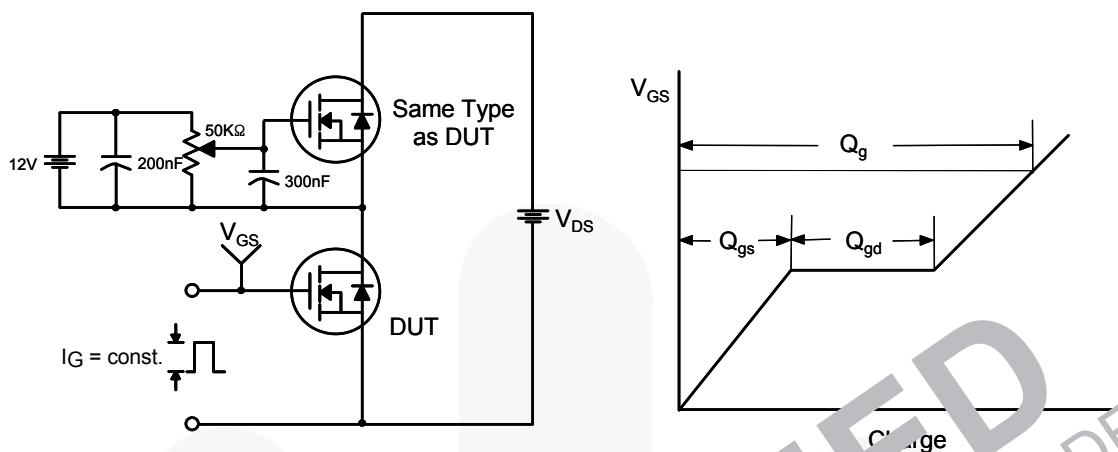


Figure 12. Gate Charge Test Circuit & Waveform

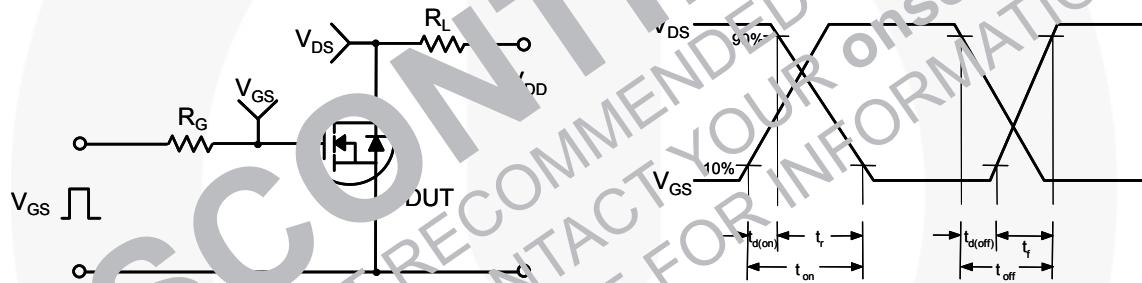


Figure 13. Resistive Switching Test Circuit & Waveforms

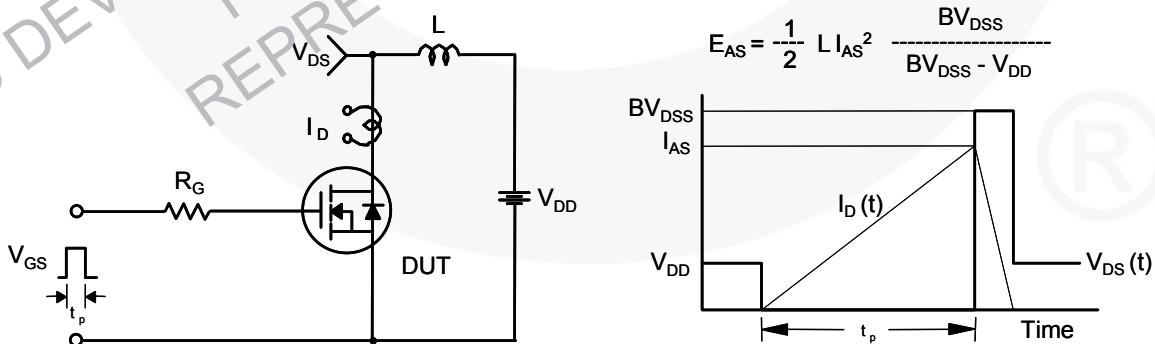
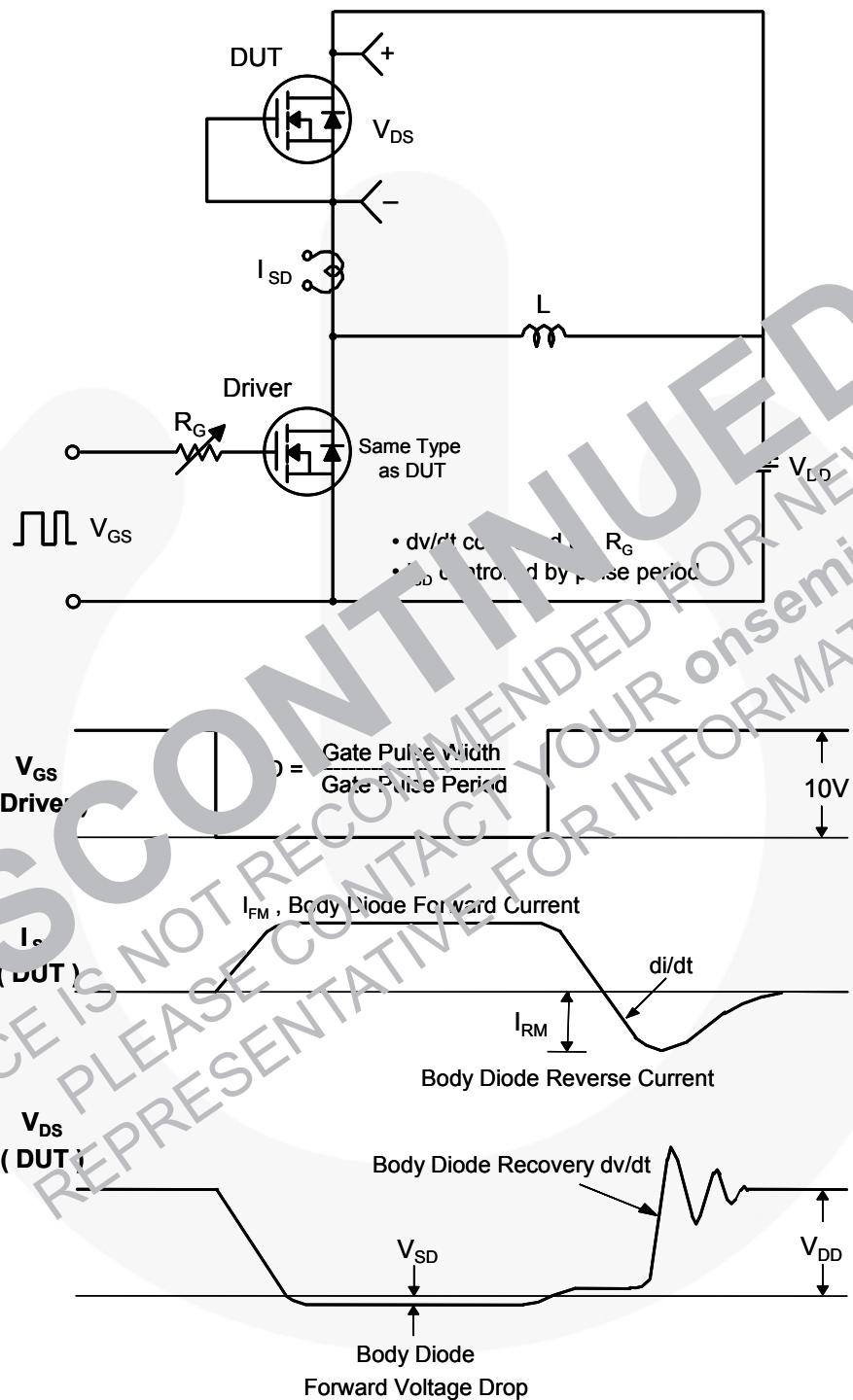


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

Mechanical Dimensions

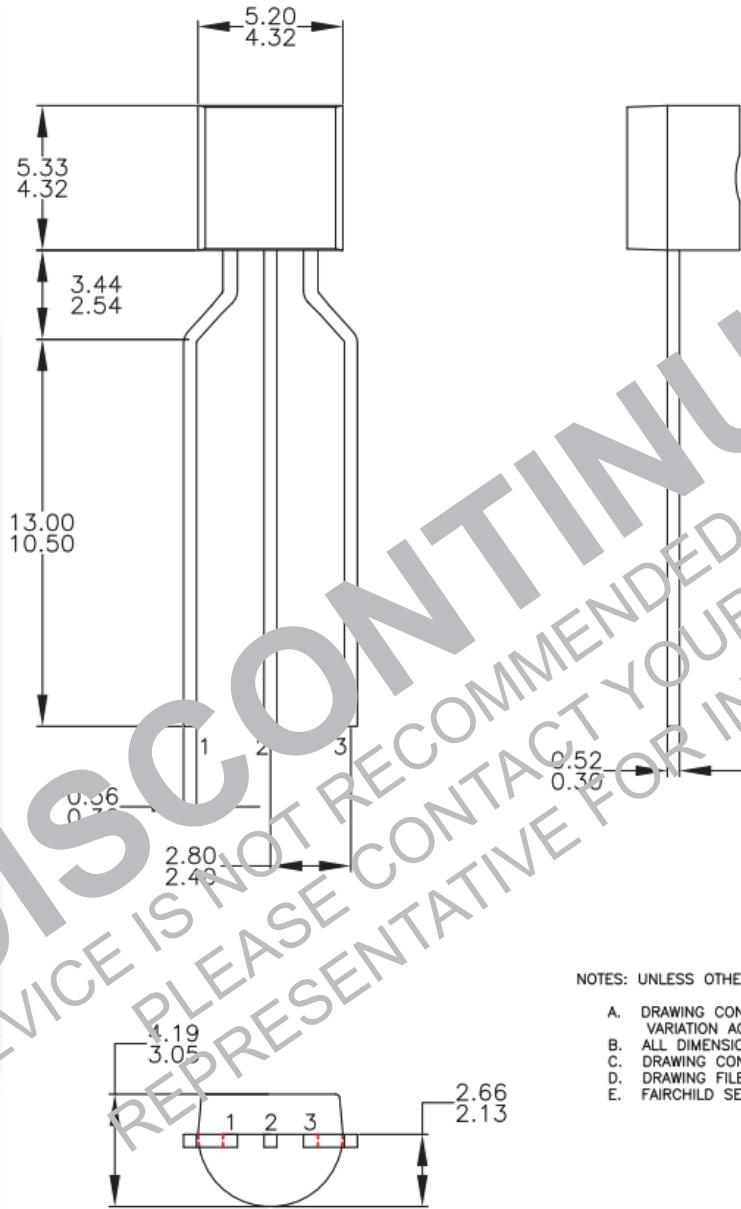


Figure 16. TO92, Molded, 3-Lead, 0.200 In Line Spacing LD Form (J61Z Option)

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